

Progress and Status of the X-Ray Microcalorimeter Spectrometer (XMS)

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Facility Science Team - GSFC





- Update on detector R&D
- Results of IDL and MDL
- Pulse processing and counting rate issues



Reference TES Approach





XO Superconducting Transition – R and I



M. Lindeman et al. 2008



Multiplexed TES calorimeter array



Also developed de-MUX software and we are now working on implementing real-time pulse height analysis



NIST X-ray array-testing facility



XO 2 x 8 pixels read out with SQUID MUX





2x8 multiplexer demonstration



Error in fit?

- Spectral database of Hölzer, et al. (1997), modified by private communication, based on *fluoresced* Mn
 - Our source is radioactive ⁵⁵Fe (K capture)
- Further investigation planned: *microcalorimeter array is the ideal tool for this measurement*



Multi Absorber TES - 1 TES, 4 absorbers

Simple approach: Separate absorbers (e.g., 4) connected to a single TES, each with a different thermal conductance.





XO New reference array layout (for Con-X)

Central, core array:

- Individual TES one absorber/TES (40 x 40)
- 2 arcmin FOV
- 2.5 eV resolution (FWHM)
- Fast (< 300 µsec time constant)

Outer, extended array

- 4 absorbers/TES
- Extends array to 52 x 52 pixels for a total of 2176 readout channels
- 5.0 arcmin FOV
- < 10 eV resolution</p>
- ~ 2 msec time constant
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Near-term Plans

Design of the photolithographic mask set for fabricating 32 x 32 arrays is underway.

Pixel pitch of 300 microns, corresponding to the size requirement for the 20 m f/l version of Con-X.

Use strip-line technology to achieve necessary electrical trace density

Plan to have first arrays for testing by December 2008.



Incorporating Micro Strip-lines

microstrip

wiring

Work towards incorporation of microstrip electrical contacts into GSFC TES arrays progressing:

> Superconducting traces separated by SiO₂ insulator

leads are needed for the high-density wiring for arrays at the 32 x 32 scale

several iterations of test devices have been fabricated and process is being refined

test devices have metallic contacts between patterned metal layers that are elsewhere isolated by an insulating layer. Different sizes to determine the smallest robust scale

each wafer also contains Nyquist chips consisting of the TES bias resistor and Nyquist inductor; these are essential elements of the TES bias circuit





Longer-term issues

Reducing thermal and electrical cross talk as the pixel count grows.

Heat sinking the array (center to perimeter) to ensure high uniformity.

Increasing MUX speed to enable 32 rows.

Optimize TES thermometer geometry for maximum pulse sensitivity.

Energy resolution of new PoST devices with ~ 6 times the area of those demonstrated.

Detector assembly – how to package > 2000 channels!

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Cryostat design adopted for recent IDL study



Estimated Mass: 257 kg

Power:				
Operating				
Average	649 W			
Peak	709W			
Standby	215 W			

Data Rate Requirement:

Average Peak 41 kbps 1680 kbps

KO Cryostat design adopted for recent IDL study





XMS configuration on spacecraft

Radiator for XMS compressor





Instrument Module Side View



Dealing with Pulse Pile-up: Event Grades





PSF Relative to Pixel Size Helps with Bright Point Sources

Gaussian PSF with HPD of 5 arcsec

20 m f/l => 10.3 arcsec/mm

0.3 mm pixels => 3 arcsec pixels

Ring	Fraction	Fraction <i>per</i> pixel
а	32.38%	32.38%
b	46.60%	5.82%
С	17.34	1.08%
d	3.33%	0.14%







Total Throughput



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Energy Resolution of various Grades

Still a lot of work being done on the best way to analyze fast, criticallydamped pulse data. How many time constants are optimal???

Simulations will be done on this in the coming months. For now we expect something like the following:

- Hi-res events will have the highest spectral resolution (e.g, 2.5 eV)
- Mid-res may be ~ twice the hi-res

Mid-res secondaries would be worse, but it should be possible to correct the pulse heights of secondary pulses. This requires a lot of calibration data (large range of Δt 's and E's!)

Low-res events will likely have > 10 eV resolution



High-speed calorimeter array

- 20 x 20 array of 1 arcsec pixels
- Distribute counts over ~ 10 times more pixels
- Use direct coupling to Si substrate for higher
- speed (~ 10's of micro-sec.)



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XMS data rate requirements

<u>Average</u>

- 40 kbps Average Science Data Rate (no contingency)
 - Equivalent to 5 m Crab source
 - 125 cps/mCrab (based on May 2008 (TBR) NASA IXO mirror concept, Randall Smith calculation)
 - 64 bits per count (photon)
- 1 kbps Engineering data rate
- Total Average Data rate:
 - 41 kbps without contingency
 - 53 kbps with contingency (30%)

Maximum

From original Con-X (four detector systems), the system requirement was 4 x 10,000 cps =40,000 cps

Assuming 42 bits/event using compression from smaller Δt's, this corresponds to 1680 kbps.



XMS Peak Data Rate

From original Con-X (four detector systems), the system requirement was 4 x 10,000 cps =40,000 cps

Assuming 42 bits/event using compression from smaller Δt 's, this corresponds to 1680 kbps.